

# S1P09R120CSE-A Preliminary

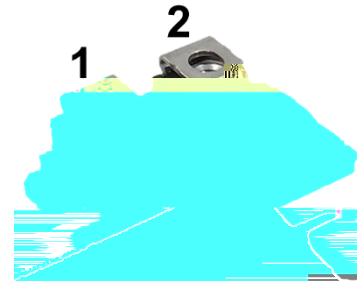


1200V / 9

Power Module

## Features

- High-speed switching possible
- Very low switching losses
- High blocking voltage with low on-resistance
- Temperature independent turn-off switching losses
- Ultra-low thermal resistance
- Common source topology
- Isolated back-side



## Applications

- Solar power optimizer
- UPS system
- Solid state circuit breaker
- High power converters
- Photovoltaics, wind power generation
- Induction heating equipment
- Smart grid transmission and distribution

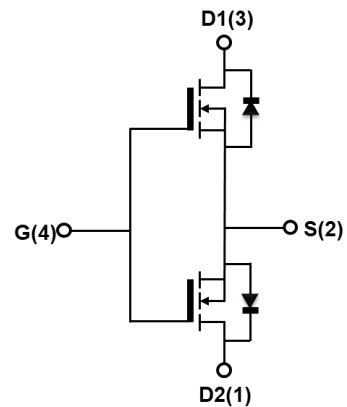


Table 1 Key performance and package parameters

Type	$V_{DS}$	$I_{DS}$ ( $T_C = \quad, R_{th(j-c,max)}$ )	$R_{DS(ON), typ}$ ( $V_{GS} = 18V, I_D = 100A,$ $T_J = \quad$ )	$T_{j,max}$	Package
S1P09R120CSE-A	1200V	240A	9m	175	SOT227

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## 1200V SiC Power MOSFET Module

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### 1 Maximum ratings

**Table 2** Maximum rating ( $T_c = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
$V_{DS,max}$	Drain source voltage	1200	V	$V_{GS} = 0V, I_D$	
$V_{GS,max}$	Gate source voltage	-8 /+22	V	Absolute maximum values	
$V_{GSop}$	Gate source voltage	-4 /+18	V	Recommended operational values	
$I_D$	Continuous drain current	240	A	$V_{GS} = 18V, T_C$	
		160		$V_{GS} = 18V, T_C$	
$I_{D(pulse)}$	Pulsed drain current	480	A	Pulse width $t_p$ limited by $T_{j,max}$	
$P_D$	Power dissipation	375	W	$T_C = 25^\circ\text{C}, T_J = 175^\circ\text{C}$	
$T_J, T_{stg}$	Operating Junction and storage temperature	-55 to +175			

## 2 Thermal / Packaging Characteristics

**Table 3 Package Characteristics**

Symbol	Description	Min.	Typ.	Max.	Unit	Note
$R_{th-JC}$	Thermal Resistance, Junction to Case	-	0.4	-		
$V_{ISO}$	Isolation Test Voltage RMS, f=50Hz, t=1min	2.5	-	-	kV	
Creepage	Terminal to Heatsink Creepage Distance	-	8.5	-	mm	
	Terminal to Terminal Creepage Distance	-	10.5	-	mm	
Clearance	Terminal to Heatsink Clearance	-	6.8	-	mm	
	Terminal to Terminal Clearance	-	4.4	-	mm	
$T_{jmax}$	Maximum Junction Temperature	-	175	-		
$T_{jop}$	Operation Junction Temperature	-	-55 to +175	-		
$T_{STG}$	Storage Temperature Range	-	-55 to +175	-		
W	Weight	-	28.5	-	g	
$T_M$	Screws to Heatsink Mounting Torque	-	-	1.5	N·m	
$T_C$	Terminal Connection Torque (M4 *8mm)	-	-	1.3	N·m	

<sup>1</sup> Not subject to production test. Parameter verified by design/characterization.

### 3 Electrical characteristics

**Table 4** SiC MOSFET characteristics (Tc = 25°C unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note
$V_{(BR)DSS}$	Drain-source breakdown voltage	1200	-	-	V	$V_{GS} = 0V, I_D$	
$V_{GS(th)}$	Gate threshold voltage	2.3	2.8	4.0	V	$V_{DS} = V_{GS}, I_D = 40mA$	
		-	2.0	-	V	$V_{DS} = V_{GS}, I_D = 40mA,$ $T_J = 175^\circ C$	
$I_{DSS}$	Zero gate voltage drain current	-	1	10		$V_{DS} = 1200V, V_{GS} = 0V$	
$I_{GSS}$	Gate source leakage current	-	-	100	nA	$V_{GS} = 18V, V_{DS} = 0V$	
$R_{DS(on)}$	Current drain-source on-state resistance	-	8.5	11		$V_{GS} = 18V, I_D = 140A$	
		-	13.5	-		$V_{GS} = 18V, I_D = 140A,$ $T_J = 175^\circ C$	
$g_{fs}$	Transconductance	-	118	-	S	$V_{DS} = 20V, I_D = 140A$	
		-	98	-		$V_{DS} = 20V, I_D = 140A,$ $T_J = 175^\circ C$	
$R_{g,int}$	Internal gate resistance	-	1.0	-		$V_{AC} = 25mV, f = 1MHz,$ open drain	
$C_{iss}$	Input capacitance	-	8521	-	pF	$V_{DS} = 1000V, V_{GS} = 0V$ $T_J = 25^\circ C, V_{AC} = 25mV$ $f = 100KHz$	
$C_{oss}$	Output capacitance	-	347	-			
$C_{rss}$	Reverse capacitance	-	15	-			
$Q_{gs}$	Gate source charge	-	54	-	nC	$V_{DS} = 800V,$ $V_{GS} = -4/+18V$ $I_D = 100A$	
$Q_{gd}$	Gate drain charge	-	45	-			
$Q_g$	Gate charge	-	230	-			

\* By estimated

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$E_{on}$	Turn on switching energy	-	812	-			
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$E_{off}$

$V_{DS} = 800V, V_{GS} = -4/+18V$   
 $I_D = 100A, R_g = 2.5 \text{ } \Omega$  ,  
 $L = 16.7 \text{ nH}$

**Table 5 Body diode characteristics**

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note
$V_{SD}$	Diode forward voltage	-	3.8	-	V	$V_{GS} = -4V, I_{SD} = 70A$	Fig.8,9, 10
		-	3.6	-	V	$V_{GS} = -4V, I_{SD} = 70A$ $T_J = 175^\circ C$	
$I_S$	Continuous diode forward current	-	240	-	A	$V_{GS} = -4V, T_c = 25^\circ C$	
$t_{rr}$	Reverse recovery time	-	66	-	ns	$V_R = 800V, V_{GS} = -4V$ $I_D = 100A$ $T_J = 175^\circ C$	
$Q_{rr}$	Reverse recovery charge	-	1830	-	nC		
$I_{rrm}$	Peak reverse recovery current	-	52	-	A		

Note : When using SiC Body Diode the maximum recommended  $V_{GS} = -4 V$

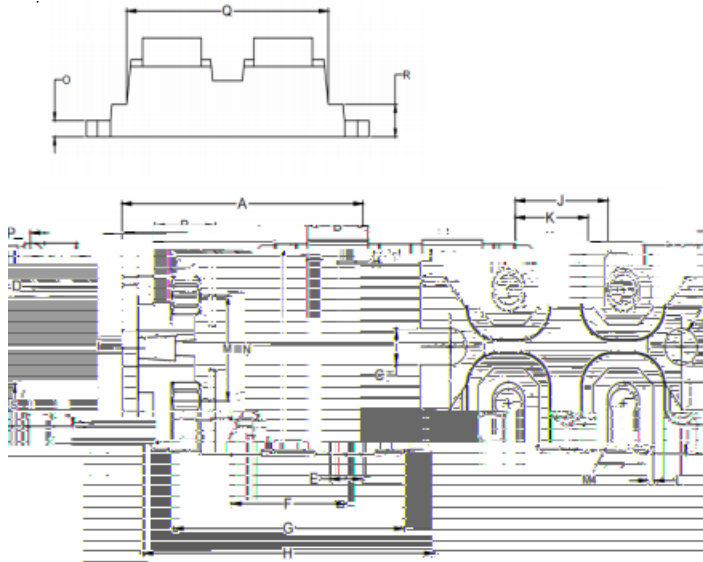


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## 1200V SiC Power MOSFET Module

### 4 Package drawing



DIM	Millimeter	
	Min	Max
A	31.40	31.60
B	7.70	8.10
C	4.20	4.40
D	4.20	4.40
E	4.10	4.30
F	14.90	15.10
G	30.10	30.20
H	38.00	38.40
I	23.80	24.20
J	11.80	12.20
K	9.40	9.60
L	0.75	0.85
M	12.40	12.80
N	24.50	25.40
O	1.90	2.10
P	3.10	3.95
Q	26.60	27.00
R	3.80	4.20
S	5.10	5.40

## 1200V SiC Power MOSFET Module

## 5 Test conditions

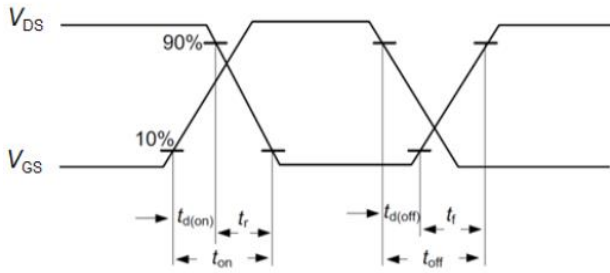


Figure A. Definition of switching times

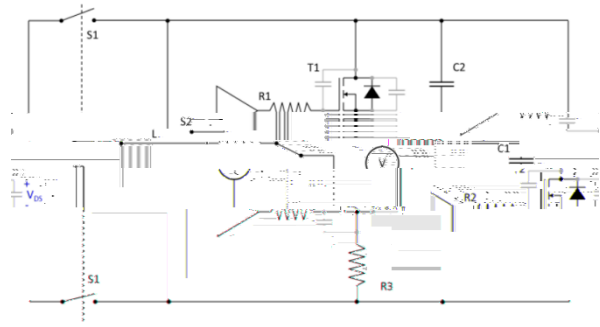


Figure B. Dynamic test circuit

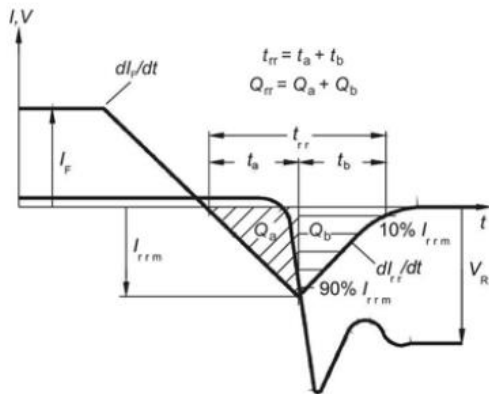


Figure C. Definition of diode switching characteristics

Figure C. Definition of body diode switching characteristics

## Revision history

Document version	Date of release	Description of changes	
V01_00	2024-05-26		

## Attention

### 1. Rohs compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/ EC (RoHS2), as implemented January 2, 2013.

### 2. REACH compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Sichain representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

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8. For use of our products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a Sichain representatives, for example but not limited to: transportation equipment, primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, and power transmission systems.